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UNITED STATES PATENT APPLICATION

FOR

**METHOD, APPARATUS, AND SYSTEM FOR HIGH SPEED DATA TRANSFER
USING SOURCE SYNCHRONOUS DATA STROBE**

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METHOD, APPARATUS, AND SYSTEM FOR HIGH SPEED DATA TRANSFER USING SOURCE SYNCHRONOUS DATA STROBE

RELATED APPLICATIONS

5 This application claims the benefit of U.S. Provisional Application No.
60/175,835, filed January 13, 2000.

FIELD OF THE INVENTION

 The present invention relates generally to the field of data transfer technology.
More specifically, the present invention relates to a method, apparatus, and system for
10 high speed data transfer using source synchronous data strobe.

BACKGROUND OF THE INVENTION

 Currently, graphics controllers/accelerators such as the Intel 740 supports local
memory interface from 66.67MHz to 100MHz. A typical graphics controller such as the
Intel 740 has its own local memory that can be SDRAM or Dual Data Rate SDRAM.
15 DDR SDRAM specifies data transfers at 2x the maximum transfer rate. For a 100 MHz
DDR SDRAM, control would be transferred at 1x speed (e.g., once every 100 MHz
clock) whereas data would be transferred at 2x speed (twice every 100 MHz clock). As
DRAM vendors move their silicon to next generation processes (e.g., less than or equal to
0.25 microseconds), the capability to produce higher frequency SDRAM parts will
20 increase up to a maximum of 150 MHz at the system level. The loading on control
signals is higher than that on data lines which restricts going beyond 150 MHz. DDR
takes advantage of the lighter data load and increases the data transfer rate. As a result,
graphics controllers/accelerators need to be able to accommodate high speed data transfer
at higher frequencies than 100 MHz.

SUMMARY OF THE INVENTION

According to one aspect of the invention, a method is provided in which a write
5 strobe signal is generated to latch output data into a memory unit that comprises one or
more dual data rate synchronous dynamic random access memory (DDR-SDRAM)
devices. The write strobe signal has an edge transition at approximately the center of a
data window corresponding to the output data. A first receive clock signal is delayed by
a first delay period using a delay locked loop (DLL) circuit to generate a first delayed
10 receive clock signal. The first delayed receive clock signal is used to latch incoming data
from the memory unit.

BRIEF DESCRIPTION OF THE DRAWINGS

The features and advantages of the present invention will be more fully
5 understood by reference to the accompanying drawings, in which:

Figure 1 shows a block diagram of one embodiment of a system according to the teachings of the present invention;

Figure 2 shows a block diagram of one embodiment of a graphics controller/accelerator;

10 **Figure 3** is a block diagram of one embodiment of a local memory interface unit according to the teachings of the present invention;

Figure 4 shows a differential clocking diagram;

Figure 5 shows a block diagram of one embodiment of a memory PLL circuit according to the teachings of the present invention;

15 **Figure 6** illustrates a block diagram of a local memory I/O structure showing the various interface signals between the local memory interface unit and the local memory; and

Figure 7 shows an example of a timing diagram showing various interface signals in Figure 6.

DETAILED DESCRIPTION

In the following detailed description numerous specific details are set forth in order to provide a thorough understanding of the present invention. However, it will be appreciated by one skilled in the art that the present invention may be practiced without these specific details.

The present invention provides a method, apparatus, and a system that allows high speed data transfer at higher frequencies than 100 MHz. The high speed data transfer can be achieved by using a centered write strobed data latching and delay locked loop (DLL) based strobeless read data latching. It is assumed that DDR SDRAM specifications will include the following improvements: differential clocking; differential input buffers; additional strobe input; improved input loading; and SSTL electricals (if required). In one embodiment, a write strobe signal is generated to latch output data transmitted from a transmitting agent (e.g., a memory interface unit of a graphics accelerator) into a memory unit (e.g., a local memory unit coupled to the graphics accelerator). The memory unit, in one embodiment, includes one or more dual data rate synchronous dynamic random access memory (DDR-SDRAM) devices. The write strobe signal is aligned with respect to the data window corresponding to the output data so that the edge transition of the write strobe signal occurs at about the center of the data window. In one embodiment, a first receive signal is delayed by a first delay period using a delay locked loop (DLL) circuit to generate a first delayed receive clock signal. The first delayed receive clock signal is used to latch incoming data from the memory unit. In one embodiment, the first delayed receive clock signal is used to clock a latching device to latch incoming data from the memory unit. The incoming data is latched in response to the edge transition of

the first delayed receive clock signal. In one embodiment, the first delayed receive clock signal is aligned with respect to the data window corresponding to the incoming data so that the edge transition of the first delayed receive clock signal occurs at such a point to provide sufficient setup time and hold time for the latching device to timely latch the

5 incoming data from the memory unit. In one embodiment, the DLL circuit is programmable using a register. The first delay period is adjustable using a value stored in the register. The teachings of the present invention are applicable to any memory interface or memory controller that is used to control the data transfer between a graphics accelerator/controller and a corresponding local memory unit. However, the teachings of

10 the present invention are not limited to the memory interfaces between graphics controllers and their corresponding local memory units and can also be applied to any other scheme, method, apparatus, or system for high speed data transfer between a host device and a memory device.

Figure 1 shows a block diagram of one embodiment of a system 100 according to

15 the teachings of the present invention. The system 100 as shown in Figure 1 includes one or more processors 110, a chipset unit 120, a system memory unit 130, a graphics controller/accelerator unit 140, a local memory unit 150, and various I/O devices 160. For the purposes of the present specification, the term “processor” or “CPU” refers to any machine that is capable of executing a sequence of instructions and shall be taken to

20 include, but not be limited to, general purpose microprocessors, special purpose microprocessors, multi-media controllers and microcontrollers, etc. In one embodiment, the processors 110 are general-purpose microprocessors that are capable of executing an Intel Architecture instruction set. The chipset unit 120 is coupled to the processor 110 via a host bus 115 and coupled to the memory unit 130 via a memory bus 125. The graphics

controller/accelerator 140 is coupled to the chipset unit 120 via an AGP bus 145. In one embodiment, the chipset unit 120 may be an Intel chipset. In one embodiment, the graphics controller/accelerator 140 may be an Intel graphics accelerator. The teachings of the present invention, however, are not limited to Intel products and/or architecture and are applicable to any other products and/or architecture. In one embodiment, the chipset unit 120 includes a memory control unit (not shown) that controls the interface between various system components and the system memory unit 130. The various I/O units 160, in one embodiment, are coupled to the chipset unit 120 via an I/O bus or PCI bus 165.

Figure 2 shows a block diagram of one embodiment 200 of the graphics controller/accelerator 140 described in Figure 1. The graphics controller 140, in one embodiment, includes an AGP interface 210, a PCI interface 220, a local memory interface 230, a clocks and reset unit 240, a general purpose I/O unit 250, a video interface 260, a display interface 270, a digital TV Out unit 280, and a BIOS ROM 290. The structure and operation of the local memory interface unit 230 are described in more detail below. In one embodiment, the local memory interface 230 controls the interface (e.g., data transfer) between the graphics accelerator 140 and the local memory unit 150.

Figure 3 shows various signal interfaces between the local memory interface unit 230 and the local memory 150. As shown in Figure 3, the local memory interface unit 230 sends data, control, and clock signals to the local memory unit 150 (e.g., SDRAM). The local memory interface unit 230 also receives data from the local memory 150. In one embodiment, the control and clock signals are used by the local memory interface unit 230 to facilitate and control the data transfer between the local memory interface unit 230 and the local memory 150.

Figure 4 shows a differential clocking diagram of two clock signals oCLK and oCLK# generated by the graphics accelerator 140 to facilitate data transfer between the graphics accelerator 140 and the local memory 150. In one embodiment, the graphics accelerator 140 generates two copies of the same clock phase shifted by half a clock.

5 This effectively provides 2x clocking as shown in Figure 4.

Figure 5 shows a block diagram of one embodiment of a phase locked loop (PLL) circuit 500 for generating two pairs of clock signals oCLK and iCLK that are used to facilitate data transfer between the graphics accelerator 140 and the local memory 150. In one embodiment, the PLL circuit 500 as shown in Figure 5 is contained within the local
10 memory interface unit 230. In another embodiment, the PLL circuit 500 may be a stand alone unit or contained within another unit in the graphics accelerator 140. In one embodiment, the oCLK/oCLK# pair is used for external DQ I/O and control clocking and iCLK/iCLK# pair is used internally for clocking the write strobe (also referred to as Write QS herein). In one embodiment, the iCLK is oCLK plus a delay equal to the period of the
15 FVCO of the PLL. This allows for adding a fixed PLL delay to the iCLK. This fixed delay is relatively insensitive to changes in process, temperature and voltage. Figure 5 shows the various fixed PLL delays at corresponding frequencies. At 100 MHz, N/M is 9/2 and 1/P is 1/3 which gives a PLL delay of 3.3 ns.

Figure 6 shows a block diagram of one embodiment of a local memory I/O
20 structure to facilitate data transfer between the graphics accelerator 140 and the local memory 150 (e.g., SDRAM). As shown in Figure 6, the Memory PLL 500 receives the MCLK clock input (at either 66.7 MHz or 60.0 MHz), a ratio input of 9/2 and a divide input of 3 and generates two pairs of clock signals: oCLK and oCLK#, iCLK and iCLK#. As shown in Figure 6, the oCLK signal is used to generate the tCLK (transmit clock) and

the rCLK (receive clock). The tCLK is sent to the local memory 150 (e.g., the SDRAM) and the rCLK clock is used to latch the incoming data (data reads) from the local memory 150. The rCLK is input to a DLL circuit 627 that generates a clock signal to latch input data coming from the local memory 150. In this embodiment, the DLL 627 is a

5 programmable DLL which receives the rCLK as its input and generates the output signal which is used to clock a latching device 625 to latch data coming from the local memory (data reads). The oCLK# signal is used to generate the tCLK# signal which is sent to the local memory 150 (e.g., SDRAM). The oCLK and oCLK# signals are used to clock latching devices 621 and 623, respectively. The iCLK and iCLK# are used to clock

10 latching devices 611 and 613, respectively. As shown in Figure 6, the iCLK signal is used to clock the latching device 611 to send the write data strobe signal QS to the local memory 150 for data writes. The iCLK signal is also used to clock a latching device 615 to send control signals to the local memory 150. The present invention thus provides a mechanism for high speed data transfer (more than 100 MHz) between the local memory

15 150 which uses DDR SDRAM and the graphics controller/accelerator 140 by using source synchronous data strobe for writes (i.e., the write data strobe or QS signal shown in Figure 6) and programmable DLL for reads (i.e., DLL based strobeless read data latching).

Figure 7 shows a diagram illustrating the timing of the various signals described

20 in Figures 5 and 6 above. As shown in Figure 7, the oCLK and oCLK# signals are two copies of the same clock phase shifted by half a clock. The iCLK is oCLK plus a delay equal to period of the Fvco of the PLL. The iCLK# is shifted from the iCLK by half a clock. The Write QS signal is used to trigger data writes to the local memory 150. The

rCLK and rCLK# signals are used to trigger data reads from the local memory 150 using a DLL delay as shown in Figure 6.

The invention has been described in conjunction with the preferred embodiment.

It is evident that numerous alternatives, modifications, variations and uses will be

5 apparent to those skilled in the art in light of the foregoing description.